

Inductors for standard circuits

Multilayer ferrite

MLF series



MLF2012 type



FEATURES

- The lineup includes a wide inductance range.
- Highly reliable monolithic structure with multilayer integration.
- Operating temperature range: -55 to +125°C

APPLICATION

- Smart phones, tablet terminals, tuners, LCD-TVs, PDP-TVs, audio equipment, computers, signal processing for modules etc.
- Application guides: [Smart phones/tablets](#)

PART NUMBER CONSTRUCTION

MLF	2012	D	47N	△	T	000
Series name	LxWxH dimensions 2.0x1.25x0.85 mm 2.0x1.25x1.25 mm	Characteristics	Inductance (μH)	Inductance tolerance	Packaging style	Internal code

* The " △ " of the Part Number contains the inductance tolerance code, J (±5%), K (±10%), or M (±20%).

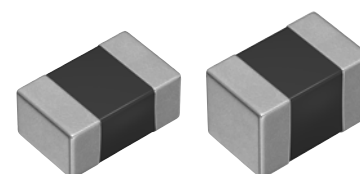
CHARACTERISTICS SPECIFICATION TABLE

L		Q		L, Q measuring conditions		Self-resonant frequency		DC resistance		Rated current	Thickness	Part No.*
μH	Tolerance	min.	typ.	Frequency (MHz)	Current (mA)	(MHz)min.	(MHz)typ.	(Ω)max.	(Ω)typ.	(mA)max.	(mm)	
0.047	±20%	15	25	50	1.0	550	700	0.10	0.05	300	0.85	MLF2012D47NMT000
0.068	±20%	15	25	50	1.0	500	600	0.15	0.08	300	0.85	MLF2012D68NMT000
0.082	±20%	15	25	50	1.0	450	550	0.15	0.08	300	0.85	MLF2012D82NMT000
0.10	±5%	20	30	25	1.0	400	500	0.15	0.10	300	0.85	MLF2012DR10JT000
	±10%											MLF2012DR10KT000
	±20%											MLF2012DR10MT000
0.12	±5%	20	30	25	1.0	360	450	0.20	0.12	300	0.85	MLF2012DR12JT000
	±10%											MLF2012DR12KT000
	±20%											MLF2012DR12MT000
0.15	±5%	20	30	25	1.0	320	410	0.20	0.13	300	0.85	MLF2012DR15JT000
	±10%											MLF2012DR15KT000
	±20%											MLF2012DR15MT000
0.18	±5%	20	30	25	1.0	280	370	0.25	0.15	300	0.85	MLF2012DR18JT000
	±10%											MLF2012DR18KT000
	±20%											MLF2012DR18MT000
0.22	±5%	20	30	25	1.0	250	330	0.30	0.16	250	0.85	MLF2012DR22JT000
	±10%											MLF2012DR22KT000
	±20%											MLF2012DR22MT000
0.27	±5%	20	30	25	1.0	220	300	0.35	0.18	250	0.85	MLF2012DR27JT000
	±10%											MLF2012DR27KT000
	±20%											MLF2012DR27MT000

Measurement equipment

Measurement item	Product No.	Manufacturer
L, Q	4294A+16034G	Keysight Technologies
Self-resonant frequency	E4991A	Keysight Technologies
DC resistance	Type-7561	Yokogawa

* Equivalent measurement equipment may be used.



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		min.	typ.	Frequency (MHz)	Current (mA)	(MHz)min.	(MHz)typ.	(Ω)max.	(Ω)typ.	(mA)max.	(mm)	
0.33	±5% ±10% ±20%	20	30	25	1.0	200	270	0.40	0.23	250	0.85	MLF2012DR33JT000 MLF2012DR33KT000 MLF2012DR33MT000
0.39	±5% ±10% ±20%	25	35	25	1.0	180	250	0.45	0.25	200	0.85	MLF2012DR39JT000 MLF2012DR39KT000 MLF2012DR39MT000
0.47	±5% ±10% ±20%	25	35	25	1.0	160	230	0.50	0.25	200	1.25	MLF2012DR47JT000 MLF2012DR47KT000 MLF2012DR47MT000
0.56	±5% ±10% ±20%	25	35	25	1.0	150	210	0.55	0.30	150	1.25	MLF2012DR56JT000 MLF2012DR56KT000 MLF2012DR56MT000
0.68	±5% ±10% ±20%	25	35	25	1.0	140	190	0.60	0.35	150	1.25	MLF2012DR68JT000 MLF2012DR68KT000 MLF2012DR68MT000
0.82	±5% ±10% ±20%	25	35	25	1.0	130	170	0.65	0.40	150	1.25	MLF2012DR82JT000 MLF2012DR82KT000 MLF2012DR82MT000
1.0	±5% ±10% ±20%	45	55	10	1.0	120	160	0.30	0.15	80	0.85	MLF2012A1R0JT000 MLF2012A1R0KT000 MLF2012A1R0MT000
1.2	±5% ±10% ±20%	45	55	10	1.0	110	150	0.35	0.15	80	0.85	MLF2012A1R2JT000 MLF2012A1R2KT000 MLF2012A1R2MT000
1.5	±5% ±10% ±20%	45	60	10	1.0	100	140	0.40	0.18	80	0.85	MLF2012A1R5JT000 MLF2012A1R5KT000 MLF2012A1R5MT000
1.8	±5% ±10% ±20%	45	60	10	1.0	90	130	0.45	0.20	80	0.85	MLF2012A1R8JT000 MLF2012A1R8KT000 MLF2012A1R8MT000
2.2	±5% ±10% ±20%	45	60	10	1.0	80	120	0.50	0.22	50	0.85	MLF2012A2R2JT000 MLF2012A2R2KT000 MLF2012A2R2MT000
2.7	±5% ±10% ±20%	45	70	10	1.0	70	100	0.55	0.25	50	1.25	MLF2012A2R7JT000 MLF2012A2R7KT000 MLF2012A2R7MT000
3.3	±5% ±10% ±20%	45	70	10	1.0	60	90	0.60	0.28	50	1.25	MLF2012A3R3JT000 MLF2012A3R3KT000 MLF2012A3R3MT000
3.9	±5% ±10% ±20%	45	70	10	1.0	55	80	0.65	0.30	30	1.25	MLF2012A3R9JT000 MLF2012A3R9KT000 MLF2012A3R9MT000
4.7	±5% ±10% ±20%	45	70	10	1.0	50	70	0.70	0.35	30	1.25	MLF2012A4R7JT000 MLF2012A4R7KT000 MLF2012A4R7MT000
5.6	±5% ±10% ±20%	50	75	4	0.1	45	65	0.60	0.30	15	1.25	MLF2012E5R6JT000 MLF2012E5R6KT000 MLF2012E5R6MT000
6.8	±5% ±10% ±20%	50	75	4	0.1	40	60	0.65	0.32	15	1.25	MLF2012E6R8JT000 MLF2012E6R8KT000 MLF2012E6R8MT000
8.2	±5% ±10% ±20%	50	75	4	0.1	35	55	0.70	0.35	15	1.25	MLF2012E8R2JT000 MLF2012E8R2KT000 MLF2012E8R2MT000

Measurement equipment

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		min.	typ.	Frequency (MHz)	Current (mA)	(MHz)min.	(MHz)typ.	(Ω)max.	(Ω)typ.	(mA)max.	(mm)	
10	±5% ±10% ±20%	50	75	2	0.1	30	50	0.80	0.40	15	1.25	MLF2012E100JT000 MLF2012E100KT000 MLF2012E100MT000
12	±5% ±10% ±20%	50	75	2	0.1	25	45	0.90	0.50	15	1.25	MLF2012E120JT000 MLF2012E120KT000 MLF2012E120MT000
15	±10% ±20%	30	45	1	0.1	22	40	0.70	0.35	5	1.25	MLF2012C150KT000 MLF2012C150MT000
18	±10% ±20%	30	45	1	0.1	20	38	0.80	0.38	5	1.25	MLF2012C180KT000 MLF2012C180MT000
22	±10% ±20%	30	45	1	0.1	18	35	0.90	0.45	5	1.25	MLF2012C220KT000 MLF2012C220MT000
27	±10% ±20%	30	45	1	0.1	17	33	1.00	0.50	5	1.25	MLF2012C270KT000 MLF2012C270MT000
33	±10% ±20%	30	45	0.4	0.1	15	28	1.10	0.55	5	1.25	MLF2012C330KT000 MLF2012C330MT000
39	±10% ±20%	35	55	2	0.1	13	23	2.40	1.30	4	1.25	MLF2012K390KT000 MLF2012K390MT000
47	±10% ±20%	35	55	2	0.1	11	20	2.70	1.60	4	1.25	MLF2012K470KT000 MLF2012K470MT000
56	±10% ±20%	35	55	2	0.1	10	18	2.80	1.80	4	1.25	MLF2012K560KT000 MLF2012K560MT000
68	±10% ±20%	25	45	1	0.1	9	16	2.90	2.00	2	1.25	MLF2012C680KT000 MLF2012C680MT000
82	±10% ±20%	25	45	1	0.1	8	14	3.00	2.40	2	1.25	MLF2012C820KT000 MLF2012C820MT000
100	±10% ±20%	25	45	1	0.1	7	12	3.10	2.50	2	1.25	MLF2012C101KT000 MLF2012C101MT000

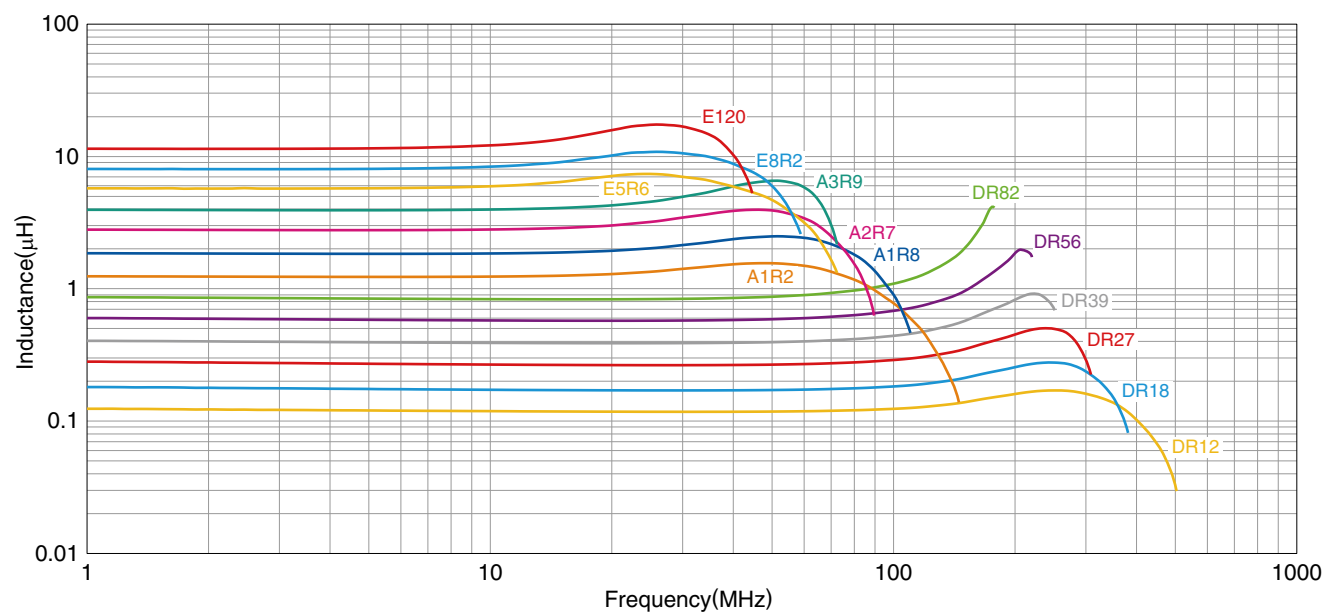
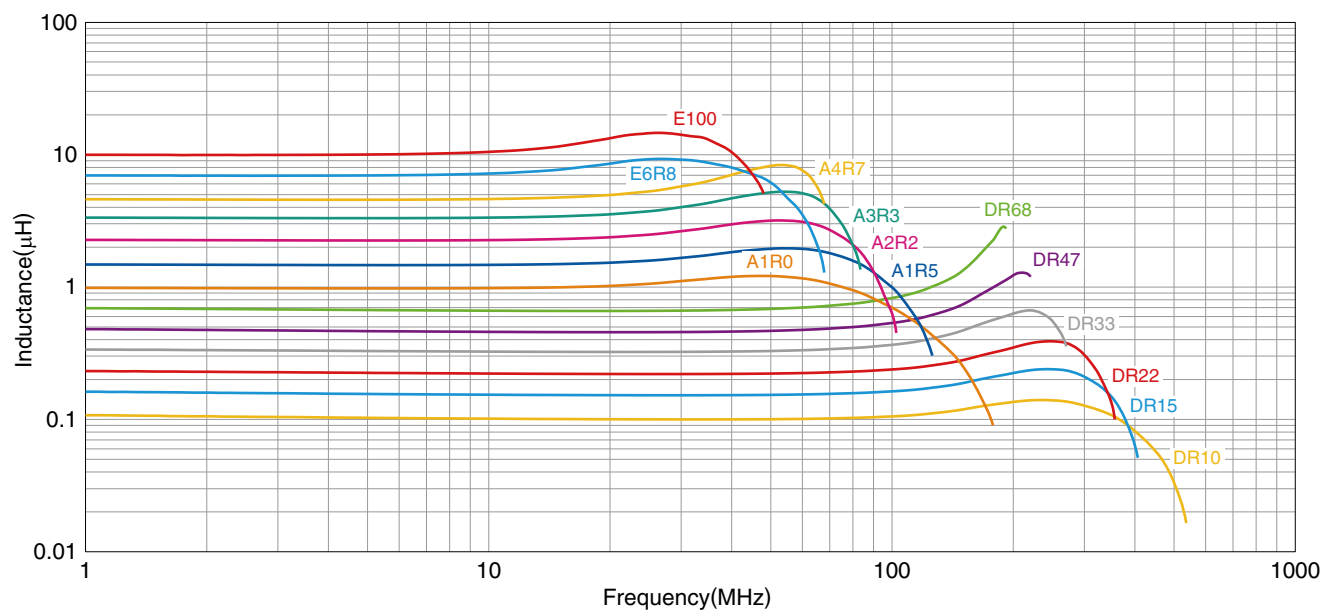
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■ L FREQUENCY CHARACTERISTICS



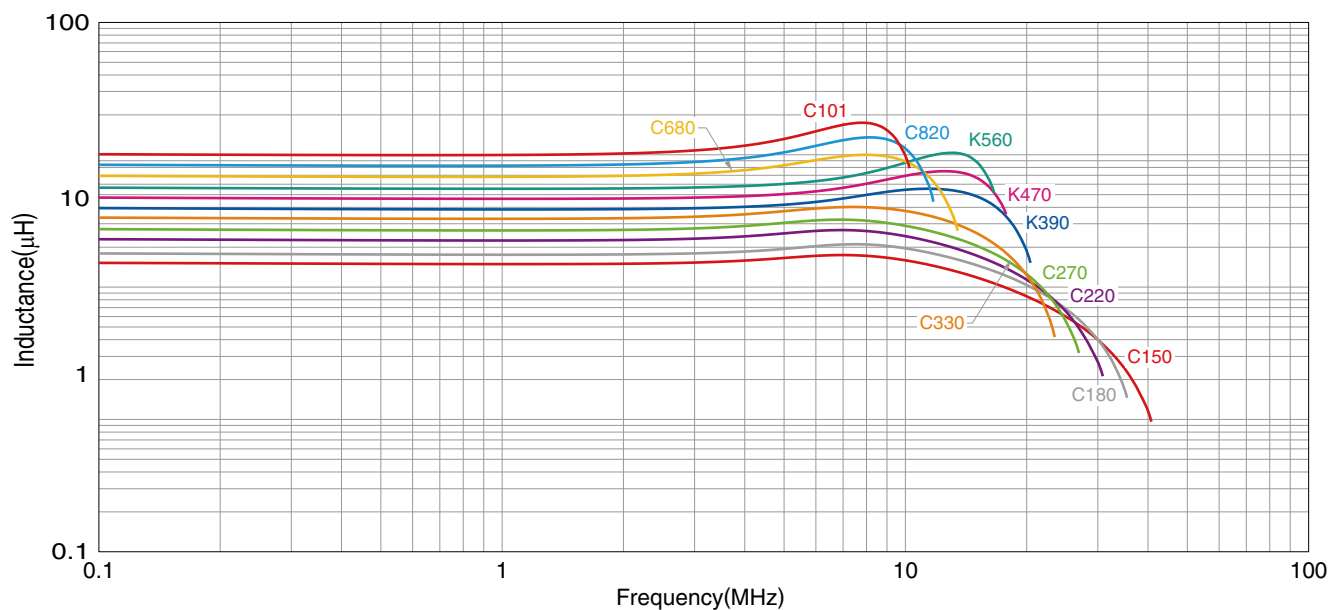
Measurement equipment

Product No.	Manufacturer
E4991A+16192A	Keysight Technologies

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MLF2012 type

L FREQUENCY CHARACTERISTICS



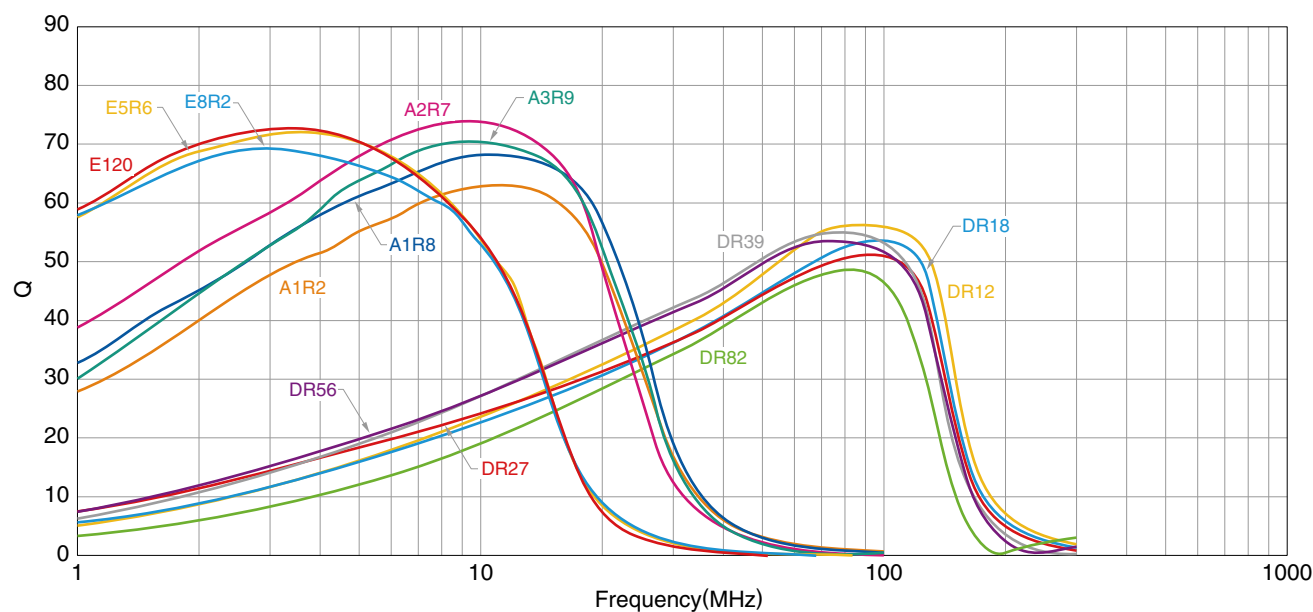
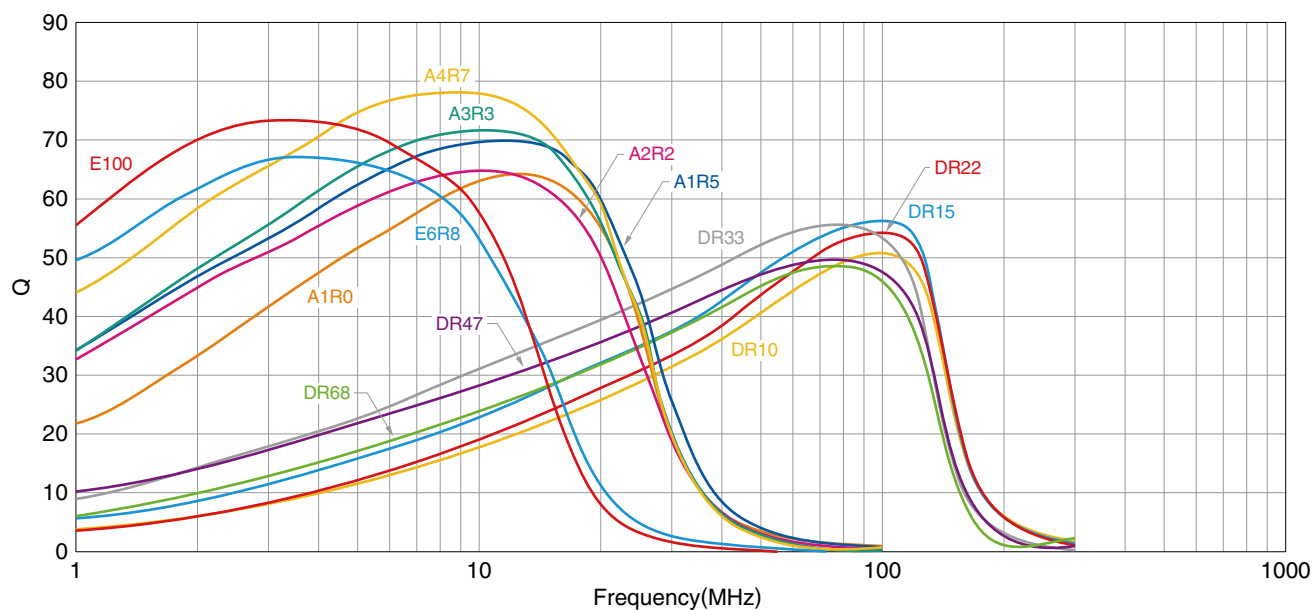
Measurement equipment

Product No.	Manufacturer
4294A+16034G	Keysight Technologies

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MLF2012 type

■ Q FREQUENCY CHARACTERISTICS



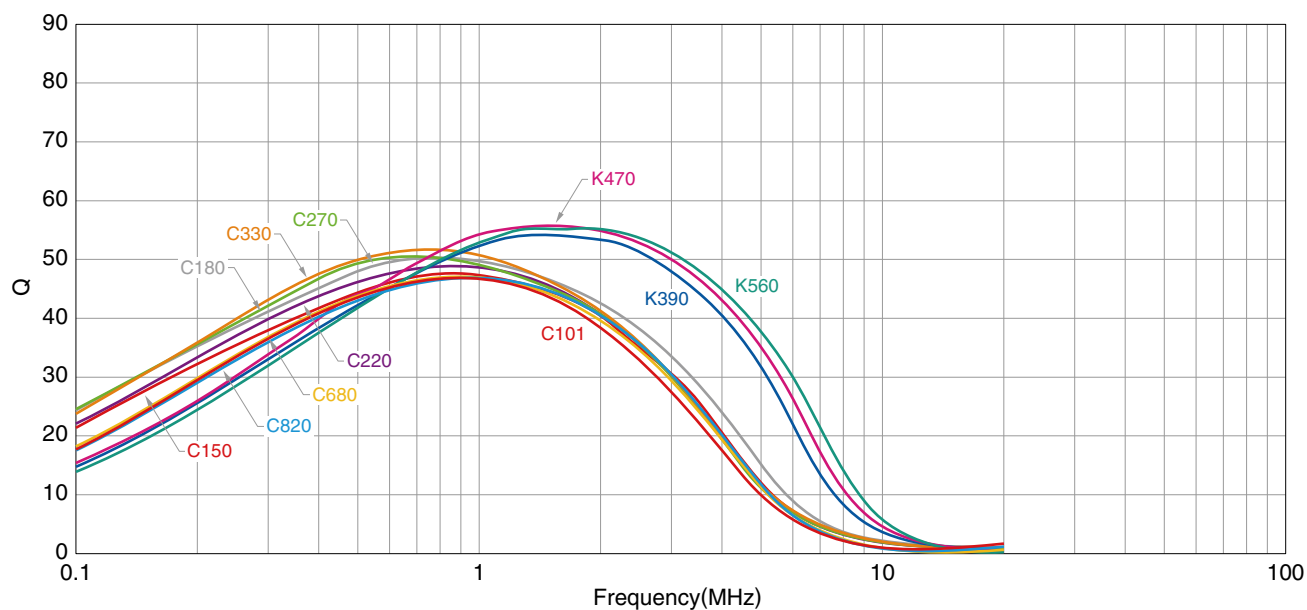
Measurement equipment

Product No.	Manufacturer
E4991A+16192A	Keysight Technologies

* Equivalent measurement equipment may be used.

MLF2012 type

Q FREQUENCY CHARACTERISTICS



Measurement equipment

Product No.	Manufacturer
4294A+16034G	Keysight Technologies

* Equivalent measurement equipment may be used.

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products.

REMINDERS

- The storage period is less than 12 months. Be sure to follow the storage conditions (temperature: 5 to 40°C, humidity: 10 to 75% RH or less).
If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
- Before soldering, be sure to preheat components.
The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications.
If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Carefully lay out the coil for the circuit board design of the non-magnetic shield type.
A malfunction may occur due to magnetic interference.
- Use a wrist band to discharge static electricity in your body through the grounding wire.
- Do not expose the products to magnets or magnetic fields.
- Do not use for a purpose outside of the contents regulated in the delivery specifications.
- The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.
The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property.
If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in the each catalog, please contact us.

- (1) Aerospace/aviation equipment
- (2) Transportation equipment (cars, electric trains, ships, etc.)
- (3) Medical equipment
- (4) Power-generation control equipment
- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.